# ONSEMÍ

# **MOSFET** – P-Channel, QFET

# -60 V, -27 A, 70 m $\Omega$

# **FQP27P06**

#### Description

This P-Channel enhancement mode power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

#### Features

- $-27 \text{ A}, -60 \text{ V}, \text{R}_{\text{DS(on)}} = 70 \text{ m}\Omega \text{ (Max.)} @ \text{V}_{\text{GS}} = -10 \text{ V}, \text{I}_{\text{D}} = -13.5 \text{ A}$
- Low Gate Charge (Typ. 33 nC)
- Low Crss (Typ. 120 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating

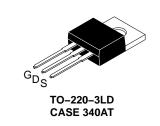
#### **ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^{\circ}C$ , unless otherwise noted)

Symbol	Parameter		FQP27P06	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		-60	V	
Ι <sub>D</sub>	Drain Current	– Continuous ( $T_C = 25^{\circ}C$ )	-27	А	
		– Continuous (T <sub>C</sub> = $100^{\circ}$ C)	-19.1		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	-108	А	
V <sub>GSS</sub>	Gate-Source Voltage		±25	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		560	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		-27	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		12	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		-7.0	V/ns	
PD	Power	(T <sub>C</sub> = 25°C)	120	W	
	Dissipation	– Derate Above 25°C	0.8	W/∘C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to +175	°C	
ΤL	Maximum Lead 1/8" from Case	300	°C		

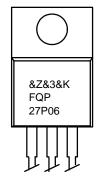
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 0.9 mH,  $I_{AS} = -27$  A,  $V_{DD} = -25$  V,  $R_{G} = 25 \Omega$ , Starting  $T_{J} = 25^{\circ}C$
- 3.  $I_{SD} \le -27$  A, di/dt  $\le 300$  A/µs,  $V_{DD} \le BV_{DSS}$ , starting  $T_J = 25^{\circ}C$ .

V <sub>DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
–60 V	70 mΩ @ –10 V	–27 A







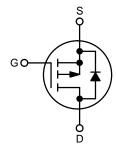
&Z = Assembly Plant Code
&3 = 3-Digit Date Code

= 2–Digits Lot Run Traceability Code

FQP27P06 = Specific Device Code

&K

#### P-CHANNEL MOSFET



#### **ORDERING INFORMATION**

Part Number	Package	Shipping
FCP380N60	TO-220-3LD (Pb-Free, Halide Free)	1000 Units / Tube

#### THERMAL CHARACTERISTICS

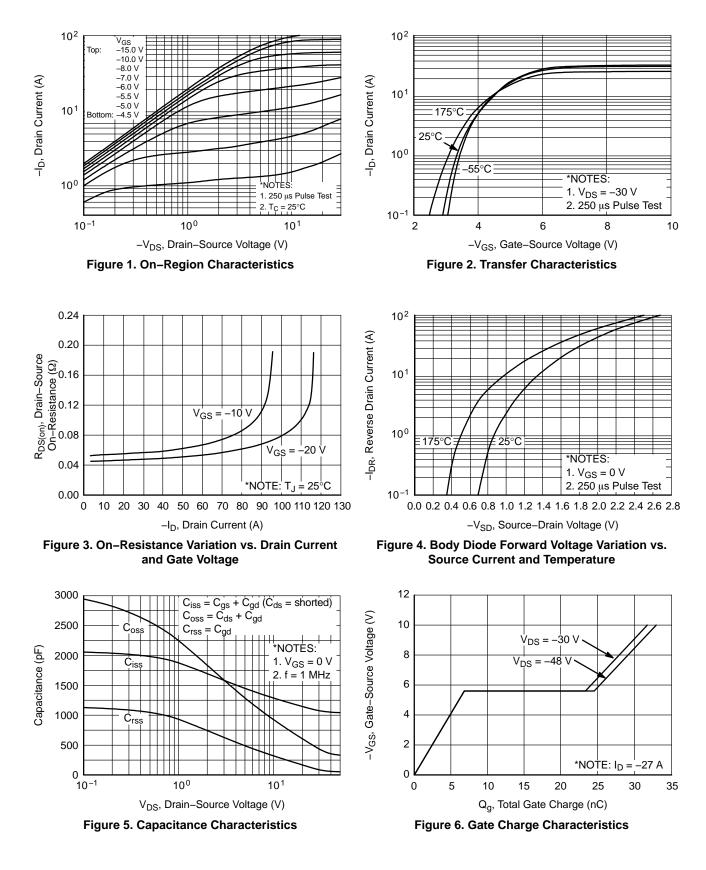
Symbol	Parameter	FQP27P06	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•				
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-60	-	_	V
${\Delta {\rm BV}_{\rm DSS}}/{\Delta {\rm T}_{\rm J}}/$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$	-	-0.06	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μΑ
	1	$V_{DS} = -48 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$	-	-	-10	
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS}$ = 25 V, $V_{DS}$ = 0 V	-	-	100	nA
ON CHARA	CTERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-2.0	-	-4.0	V
R <sub>DS(on)</sub>	Static Drain–Source On Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -13.5 \text{ A}$	-	0.055	0.07	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -30 \text{ V}, \text{ I}_{D} = -13.5 \text{ A}$	-	12.4	_	S
DYNAMIC C	CHARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$	-	1100	1400	pF
C <sub>oss</sub>	Output Capacitance		-	510	660	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	120	155	pF
SWITCHING	CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -13.5 \text{ A}, \text{ R}_{G} = 25 \Omega$	-	18	45	ns
t <sub>r</sub>	Turn–On Rise Time	(Note 4)	-	185	380	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	1	-	30	70	ns
t <sub>f</sub>	Turn–Off Fall Time		-	90	190	ns
Qg	Total Gate Charge	$V_{DS} = -48 \text{ V}, I_D = -27 \text{ A}, V_{GS} = -10 \text{ V}$	-	33	43	nC
Q <sub>gs</sub>	Gate-Source Charge	(Note 4)	-	6.8	_	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	18	_	nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND N	IAXIMUM RATINGS				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	-27	А
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	-108	А
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = -27 \text{ A}$	-	-	-4.0	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{SD} = -27 \text{ A,}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	105	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	0.41	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.4. Essentially independent of operating temperature

### **TYPICAL CHARACTERISTICS**



#### TYPICAL CHARACTERISTICS (CONTINUED)

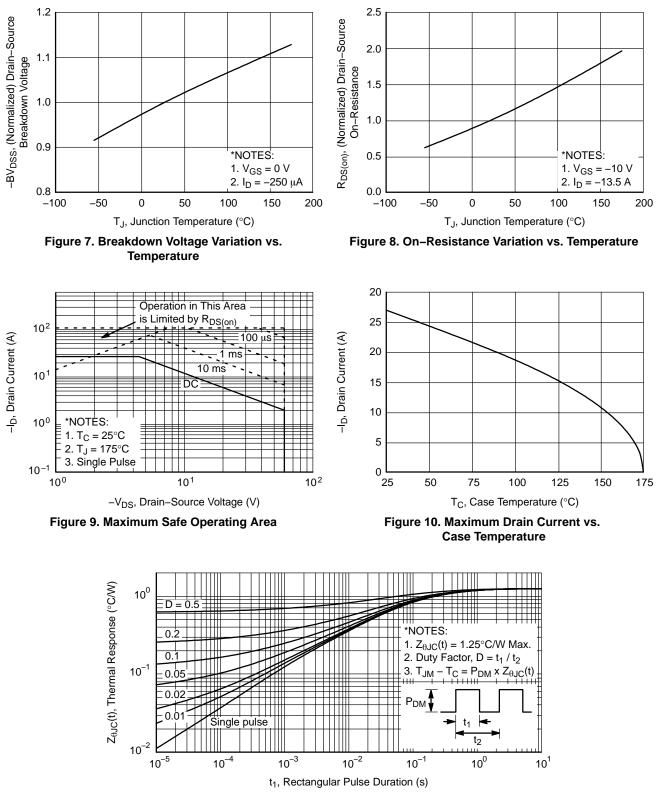


Figure 11. Transient Thermal Response Curve

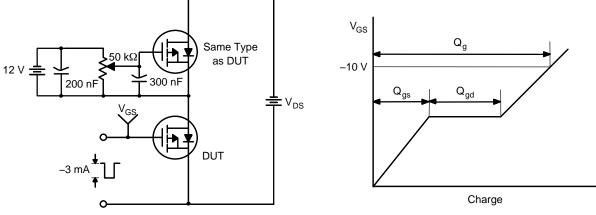


Figure 12. Gate Charge Test Circuit & Waveform

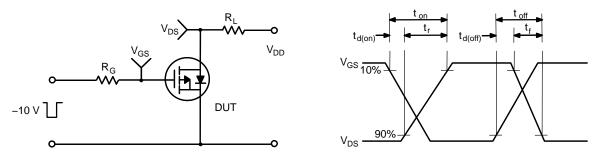


Figure 13. Resistive Switching Test Circuit & Waveforms

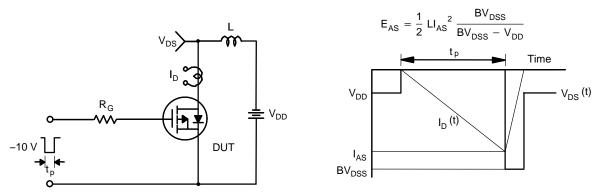


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

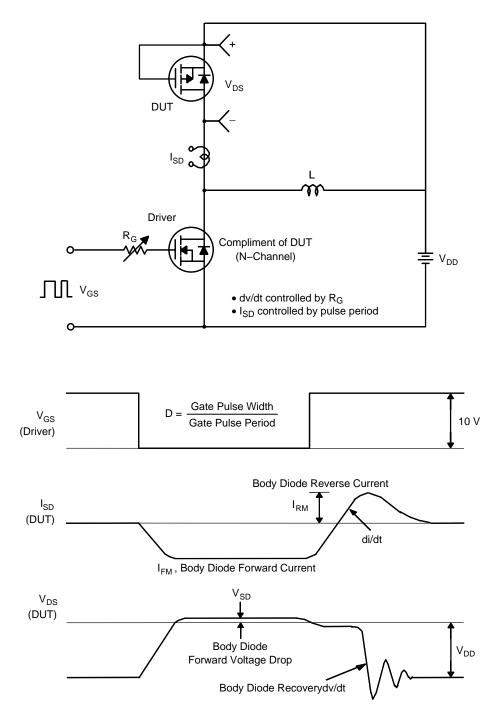
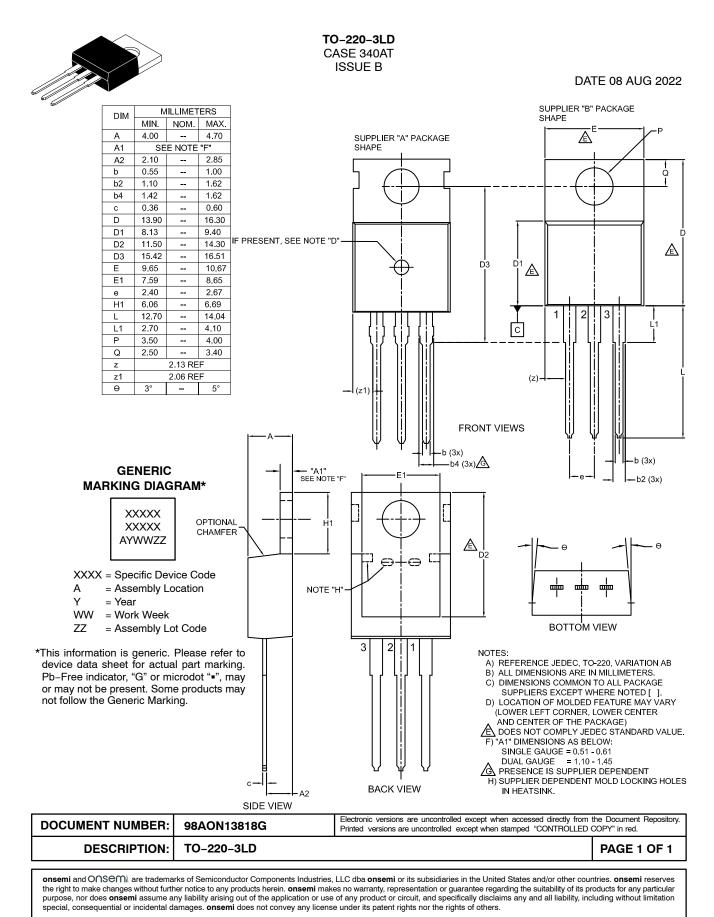


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms





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